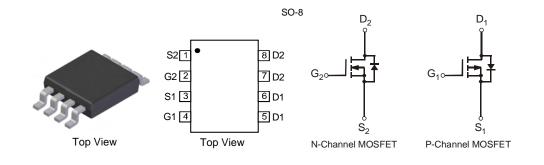


Features

- Low On-Resistance
- N-Channel: 32mΩ @ 10V 46mΩ @ 4.5V
- P-Channel: 39mΩ @ 10V 53mΩ @ 4.5V
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- Complementary Pair MOSFET
- Complementary Pair MOSFET
- Lead Free/RoHS Compliant (Note 1)
- "Green" Device (Note 2)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: SO-8
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals Connections: See Diagram
- Terminals: Finish Matte Tin annealed over Copper lead frame. Solderable per MIL-STD-202, Method 208
- Marking Information: See Page 6
- Ordering Information: See Page 6
- Weight: 0.072 grams (approximate)



Maximum Ratings N-CHANNEL – Q1 @T_A = 25°C unless otherwise specified

Char	Symbol	Value	Unit		
Drain-Source Voltage	V _{DSS}	30	V		
Gate-Source Voltage			V _{GSS}	±20	V
Continuous Drain Current (Note 3)	Steady State	T _A = 25°C T _A = 85°C	ID	8.1 5.1	А
Pulsed Drain Current (Note 4)			I _{DM}	25	А

Maximum Ratings P-CHANNEL – Q2 @T_A = 25°C unless otherwise specified

Cha	Symbol	Value	Unit		
Drain-Source Voltage	V _{DSS}	-30	V		
Gate-Source Voltage			V _{GSS}	±20	V
Continuous Drain Current (Note 3)	Steady State	$T_A = 25^{\circ}C$ $T_A = 85^{\circ}C$	ID	-7.0 -4.5	А
Pulsed Drain Current (Note 4)			I _{DM}	-25	А

Thermal Characteristics $@T_A = 25^{\circ}C$ unless otherwise specified

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 3)	PD	2.5	W
Thermal Resistance, Junction to Ambient (Note 3)	R _{θJA}	50	°C/W
Operating and Storage Temperature Range	TJ, TSTG	-55 to +150	°C

Notes: 1. No purposefully added lead.

2. Diodes Inc.'s "Green" policy can be found on our website at http://www.diodes.com/products/lead_free/index.php.

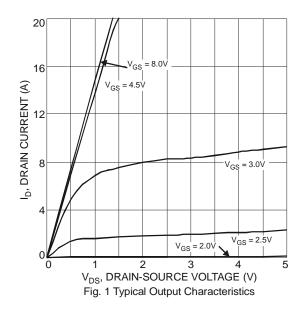
3. Device mounted on FR-4 PCB, with minimum recommended pad layout.

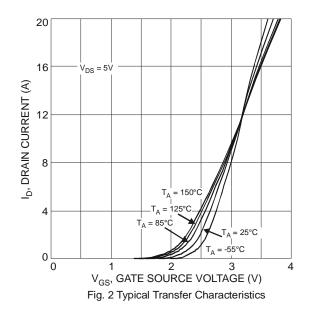
4. Repetitive rating, pulse width limited by junction temperature.



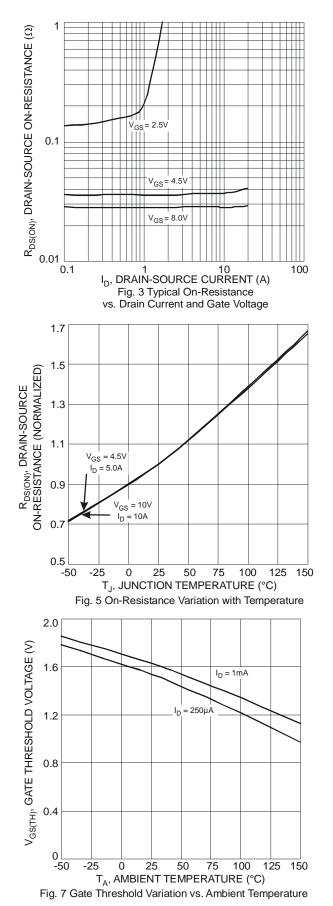
Electrical Characteristics N-CHANNEL – Q1 @TA = 25°C unless otherwise specified

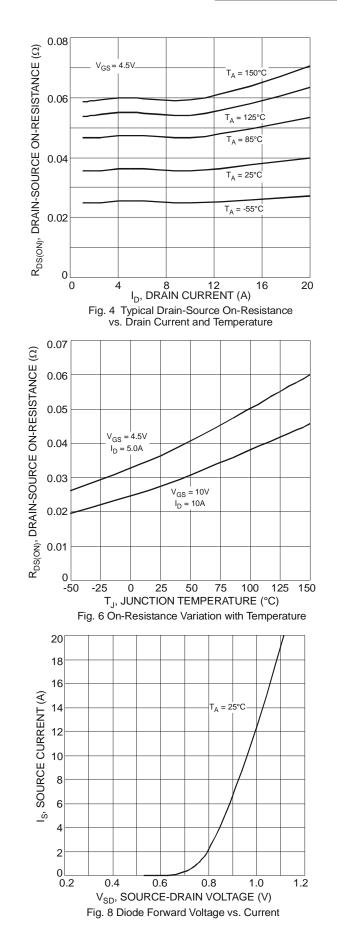
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 5)						·	
Drain-Source Breakdown Voltage	BV _{DSS}	30	-	-	V	$V_{GS} = 0V, I_D = 250\mu A$	
Zero Gate Voltage Drain Current T _J = 25°C	I _{DSS}	-	-	1.0	μA	$V_{DS} = 30V, V_{GS} = 0V$	
Gate-Source Leakage	IGSS	-	-	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 5)							
Gate Threshold Voltage	V _{GS(th)}	1	1.45	2.1	V	$V_{DS} = V_{GS}$, $I_C = 250 \mu A$	
Static Drain-Source On-Resistance	D		23	32	mΩ	$V_{GS} = 10V, I_{C} = 7A$	
Static Drain-Source On-Resistance	R _{DS (ON)}	-	32	46	11122	$V_{GS} = 4.5V, I_C = 5.6A$	
Forward Transfer Admittance	Y _{fs}	-	7.6	-	S	$V_{DS} = 5V, I_{C} = 7A$	
Diode Forward Voltage (Note 5)	V _{SD}	-	0.7	1.0	V	$V_{GS} = 0V, I_{S} = 1A$	
DYNAMIC CHARACTERISTICS (Note 6)							
Input Capacitance	Ciss	-	404.5	-	pF		
Output Capacitance	Coss	-	51.8	-	pF	− V _{DS} = 15V, V _{GS} = 0V, − f = 1.0MHz	
Reverse Transfer Capacitance	C _{rss}	-	45.1	-	pF	1 = 1.000HZ	
Gate Resistance	Rg	-	1.5	-	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	
Total Gate Charge (10V)	Qg	-	9.2	-	nC		
Gate-Source Charge	Q _{gs}	-	1.2	-	nC	$V_{GS} = 10V, V_{DS} = 15V,$	
Gate-Drain Charge	Q _{qd}	-	1.8	-	nC	$I_D = 5.8A$	
Turn-On Delay Time	t _{D(on)}	-	3.4	-	ns		
Turn-On Rise Time	tr	-	6.18	-	ns	V _{GS} = 10V, V _{DS} = 15V,	
Turn-Off Delay Time	t _{D(off)}	-	13.92	-	ns	$R_G = 3\Omega, R_L = 2.6\Omega$	
Turn-Off Fall Time	t _f	-	2.84	-	ns	1	









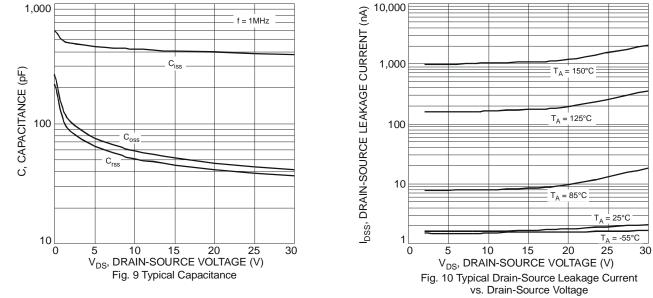


NEW PRODUCT

DMC3032LSD Document number: DS32153 Rev. 1 - 2

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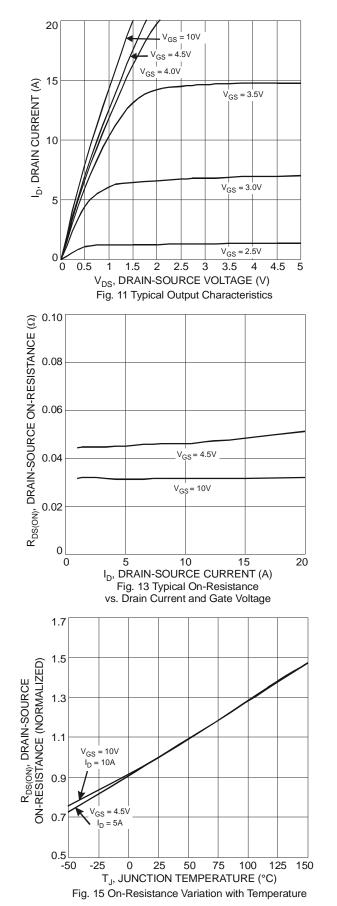


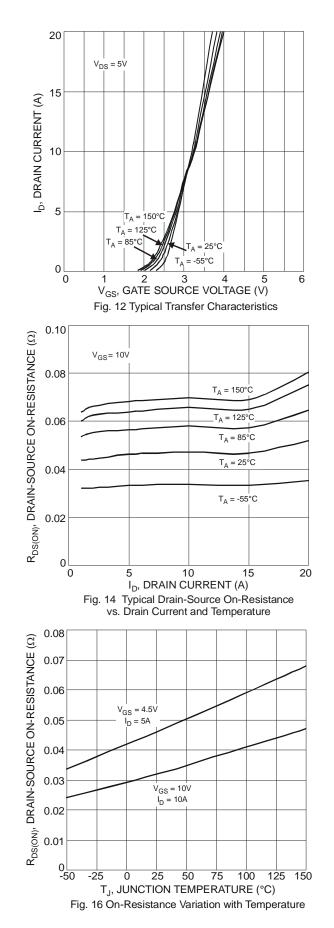
Electrical Characteristics P-CHANNEL @T _A = 25°C unless otherwise specified							
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 5)						-	
Drain-Source Breakdown Voltage	BV _{DSS}	-30	-	-	V	$V_{GS} = 0V, I_D = -250 \mu A$	
Zero Gate Voltage Drain Current T _J = 25°C	I _{DSS}	-	-	-1.0	μA	$V_{DS} = -30V, V_{GS} = 0V$	
Gate-Source Leakage	IGSS	-	-	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 5)							
Gate Threshold Voltage	V _{GS(th)}	-1	-1.7	-2.2	V	$V_{DS} = V_{GS}, I_D = -250 \mu A$	
Static Drain-Source On-Resistance	D		30	39	mΩ	$V_{GS} = -10V, I_D = -4.3A$	
Static Drain-Source On-Resistance	R _{DS (ON)}	-	42	53	11122	$V_{GS} = -4.5V, I_D = -3.7A$	
Forward Transfer Admittance	Y _{fs}	-	7	-	S	$V_{DS} = -5V, I_D = -4.3A$	
Diode Forward Voltage (Note 5)	V _{SD}	-	-0.75	-1.0	V	$V_{GS} = 0V, I_{S} = -1.7A$	
DYNAMIC CHARACTERISTICS (Note 6)						·	
Input Capacitance	Ciss	-	1002	-	pF		
Output Capacitance	Coss	-	125	-	pF	− V _{DS} = -15V, V _{GS} = 0V, − f = 1.0MHz	
Reverse Transfer Capacitance	Crss	-	118	-	pF	1 = 1.0MHz	
Gate Resistance	Rq	-	13	-	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1MHz$	
Total Gate Charge (4.5V)	Qq	-	10.1	-	nC		
Total Gate Charge (10V)	Qq	-	21.1	-	nC	$V_{GS} = -4.5V/-10V, V_{DS} = -15V,$	
Gate-Source Charge	Q _{gs}	-	2.8	-	nC	I _D = -6A	
Gate-Drain Charge	Q _{gd}	-	3.2	-	nC	7	
Turn-On Delay Time	t _{D(on)}	-	10.1	-	ns		
Turn-On Rise Time	t _r	-	6.5	-	ns	$V_{GS} = -10V, V_{DS} = -15V,$	
Turn-Off Delay Time	t _{D(off)}	-	50.1	-	ns	$R_G = 6\Omega$, $I_D = -1A$	
Turn-Off Fall Time	t _f	-	22.2	-	ns		

5. Short duration pulse test used to minimize self-heating effect. Notes:

6. Guaranteed by design. Not subject to production testing.







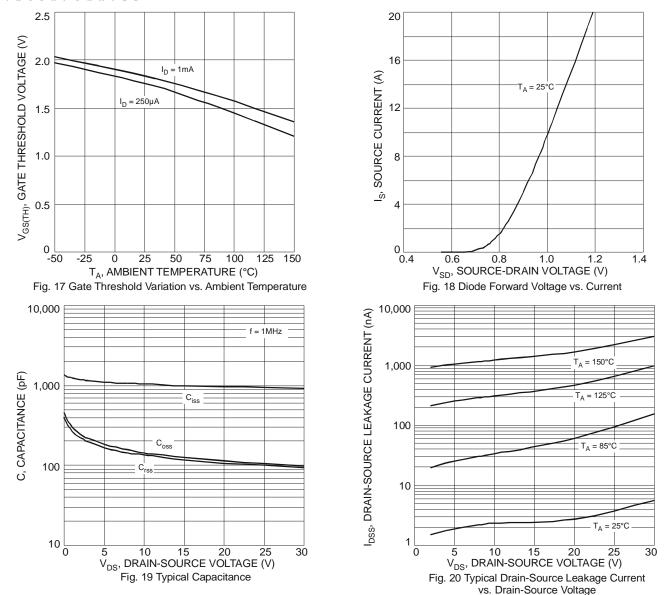
NEW PRODUCT

DMC3032LSD

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DMC3032LSD



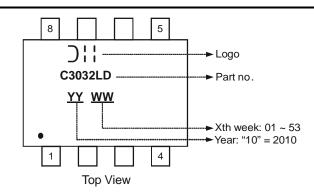


Ordering Information (Note 7)

Part Number	Case	Packaging
DMC3032LSD-13	SO-8	2500/Tape & Reel

Notes: 7. For packaging details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

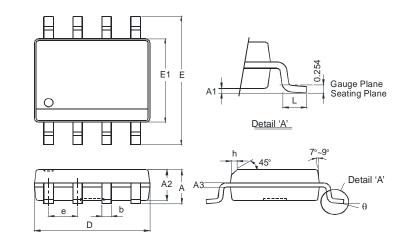
Marking Information



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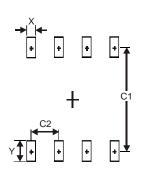


Package Outline Dimensions



SO-8					
Dim	Min	Max			
Α	-	1.75			
A1	0.10	0.20			
A2	1.30	1.50			
A3	0.15	0.25			
b	0.3	0.5			
D	4.85	4.95			
ш	5.90	6.10			
E1	3.85	3.95			
e	1.27 Тур				
h	-	0.35			
L	0.62	0.82			
θ	0°	8°			
All Dimensions in mm					

Suggested Pad Layout



Dimensions	Value (in mm)
Х	0.60
Y	1.55
C1	5.4
C2	1.27



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